

## ightarrow Pre ightarrow Inc ightarrow Inductors (Coils) ightarrow Detailed Information

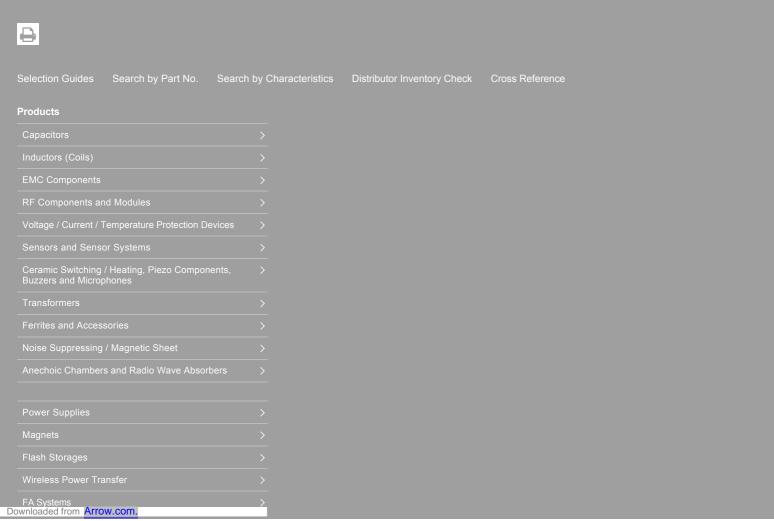
## Inductors (Coils)

Product Top Pa	age Search by Part No.	Search by Characteristics	Cross Reference	Catalog	Tech Notes	▼ more
MHQ04	402P2N8BT	000				REACH RoHS SVHC-Free Halogen Free
Applications	Commercial Gra	de				PDF file of this page
Feature	Non-Mag Core Non-Ma	Core Non-Magnetic Core (Dielectric Ceramic)		р т 1 та 1		Contact
Series   Type MHQ-P						Documents
Status	Production (Not Recommended f		) and	Images are for reference only and show exemplary products.		Catalog Catalog RoHS Certificate SVHC/REACH Certificate
Brand	TDK					Product Lineup
						[Selection Guide] Inductors for high frequency applications Update
Size						Sample Kits
Length(L)		0.44mm ±0.0	)2mm			Technical Support Tools
Width(W)		0.24mm ±0.0	0.24mm ±0.02mm			S-parameter
Thickness   He	eight	0.24mm ±0.0	0.24mm ±0.02mm			SPICE Netlist (Simple)
Recommended Land Pattern (A)		0.15mm to 0	0.15mm to 0.20mm			SPICE Netlist (Precision)
Recommended Land Pattern (B)		0.20mm Non	0.20mm Nom.			Equivalent Circuit Model
Recommended Land Pattern (C)		0.18mm to 0	0.18mm to 0.20mm			
Electrical Cha	aracteristics					
Inductance		2.8nH ±0.1nl	2.8nH ±0.1nH at 500MHz			
Rated Current		200mA	200mA			
DC Resistance [Typ.]		190mΩ				
DC Resistance [Max.]		400mΩ	400mΩ			
Self Resonant	Frequency [Min.]	6GHz	6GHz			
Self Resonant Frequency [Typ.]		8GHz	8GHz			
Q [Min.]		10 at 500MH	10 at 500MHz			
Q [Typ.]		14 at 500MH	z			
Other						
Operating Tem	p. Range (Including Self-T	emp. Rise) -55 to 125°C				
Soldering Method		Reflow	Reflow			
AEC-Q200		No				
Packing		Punched (Pa	Punched (Paper)Taping [180mm Reel]			
Package Quan	ntity	20000pcs				
Weight			0.00011g			

characteristics.)

Impedance

MHQ0402P2N8BT000	MHQ0402P2N8BT000
Change settings	Change settings
Inductance	Q
MHQ0402P2N8BT000	MHQ0402P2N8BT000
Change settings	Change settings



Transparent Conductive Film	>	
Micro Modules (Substrates with Built-in ICs, Products Utilizing with SESUB)		
Solar Cells		
Biosensor		
Application Specific IC (ASIC) Development and Supply		
Application Guides		
Technical Support		
Tech Library		
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